



PC Board Layout Component Side Shown

NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MIOHMS MAX.
4. INSULATION RESISTANCE: 500 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.
2: TAILS- 150u" TIN-LEAD MIN OVER 50u" NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191

DATA SHEET

Description: 10p8c Side entry Modular Jack shielded
6µ" gold

Part-no. SPEED: --	Part-no. customer: --
Project-no. SPEED: N-IN20Jc	Project-no. customer: --

Data sheet-no.: DBLKS1328	Designed: Frank Hesseler
Index: 0	Checked: <i>M. Heigler</i>
Date: 09.04.2004	Page: 1 of <i>1</i>

